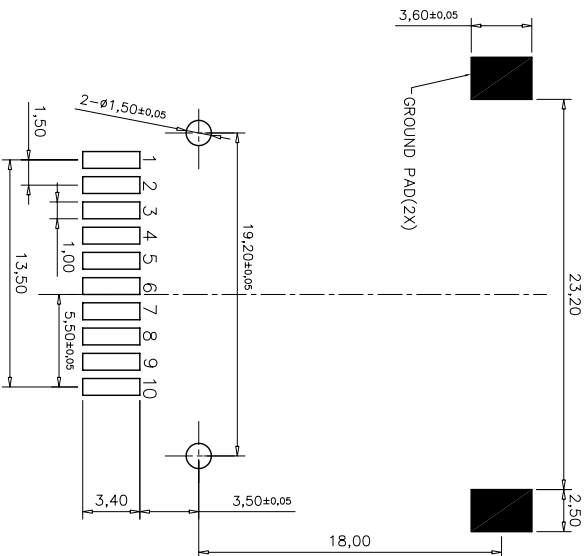
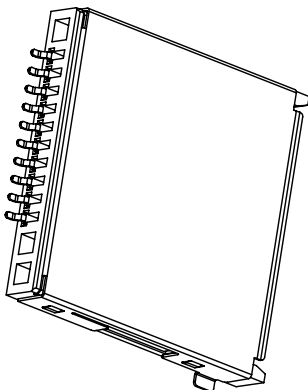
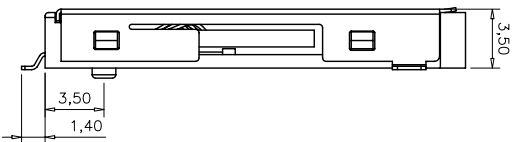
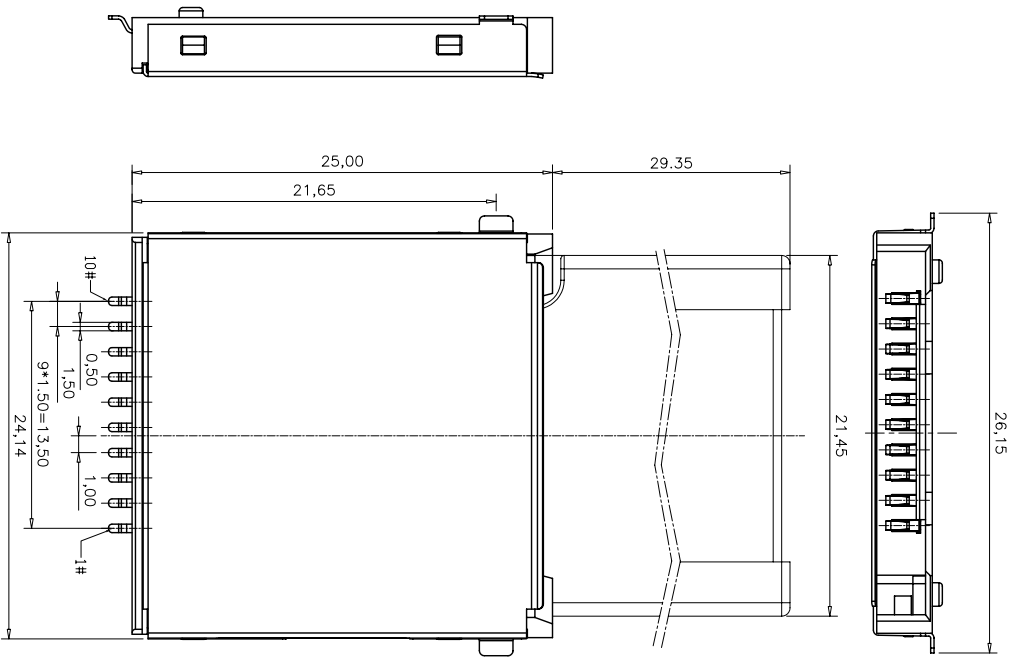


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CUSTOMER DRAWING



NOTE:
1. MATERIAL:
HOUSING: HIGH TEMP. THERMOPLASTIC, UL94-V0. COLOR: NATURAL;
CONTACT: ALLOY COPPER, THICKNESS =0.20MM;
SHELL: ALLOY COPPER, THICKNESS =0.20MM;
2. PLATING:
CONTACT: SEE ORDER P/N FOR MATING AREA,
160u" Tin PLATED ON SOLDER TAILS;
SHELL: 50u" MIN. NICKEL PLATED OVERALL, 1u" Au PLATED ON SOLDER TAILS;
3. MATERIAL SHOULD BE FULFILLED AMPHENOL SPEC# SSM002.

RECOMMENDED PCB LAYOUT(TOP VIEW)
(ALL TOLERANCES ARE ±0.05)



ORDER P/N
MS-PB-N-001-X

- Gold Plating
1. 0.076um gold Plating
2. 0.38um gold Plating
3. Gold Flash

REVISIONS			
SYM	ECN	DESCRIPTION	DATE
A	HK4434	RELEASE TO CUSTOMER	04/11'07

UNLESS OTHERWISE SPECIFIED			
TOLERANCES		APPROVAL	
U.S.	METRIC	DRAWN	DATE
±.01	±0.25	Johanson, Tod	04/11'07
±.02	±0.50	DB-Gao	04/11'07
±.05	±1.27	CHECKED	

Amphenol

TITLE
MS CONNECTOR
(FULL COVER,NORMAL TYPE)

FOR MATERIALS AND FINISHES			
SEE NOTE			
REMOVE SHARP EDGES			
DIMENSIONS			
U.S.	INCHES	ANGLE OF PROJECTION	
METRIC	MM		
A3	C	MS-PB-N-001-X	REV. A
SCALE	NONE	SHEET 1 OF 1	